

Title (en)

METHOD AND APPARATUS FOR MANUFACTURING COIL SPRINGS

Title (de)

VERFAHREN UND VORRICHTUNG ZUR HERSTELLUNG VON SPIRALFEDERN

Title (fr)

PROCEDE ET APPAREIL PERMETTANT DE FABRIQUER DES RESSORTS A BOUDIN

Publication

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Application

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Priority

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Abstract (en)

[origin: WO9853933A1] A method and apparatus for forming a length of connected, pocketed coil springs to be used in mattresses and the like where wire (10) from a supply source is heated (16) to between 450 and 500 degrees Fahrenheit by an induction heater before the wire is coiled. Thereafter, the wire is hot coiled (18), severed (20) and cooled (22) below a temperature where a permanent set might occur from further processing of the spring. Thereafter, the spring is compressed (24) in preparation for its insertion (26) into a space provided by stretchable fabric from a supply reel. The fabric (12) is folded (14) on itself to provide the space. The temperature of the spring must also be sufficiently low to contact the fabric without causing burns or other damage. After insertion of a compressed spring into the space, the fabric is ultrasonically welded (28) to create individual but connected pockets for each spring. Thereafter, the springs are oriented (30) to allow each spring to expand thereby creating the length of connected, pocketed coil springs.

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